CANH

VREF

6 CANL

D AND N PACKAGE (TOP VIEW)

> 8 ΠRS

7

5

TXN

GND [

VCC [3

RXD



- Pin Compatible with PCA82C250 and DeviceNet, SDS
- ISO11898 Compatible
- High Speed, up to 1 Mbps
- Differential Transmit to the Bus and Receive from the Bus to the CAN Controller
- At Least 110 Nodes Can Be Connected
- **100-V Transient Protection on the Transmit** Output
- 24-V Supply Cross Wire Protection on **CANH and CANL**
- No Bus Loading When Powered Down
- Operates between -40°C to 85°C
- **Unitrode DeviceNet ID#107**

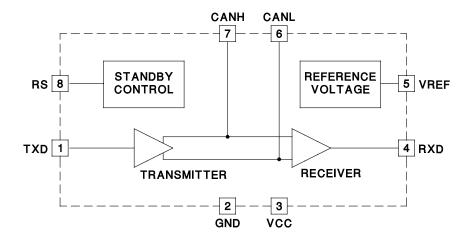
description

The UC5350 Control Area Network Transceiver (CAN Transceiver) is designed for industrial applications employing the CAN serial communications physical layer per ISO 11898 standard. The device is a high-speed transceiver designed for use up to 1 Mbps. Especially designed for hostile environments, this device features cross wire, loss of ground, overvoltage, and overtemperature protections well as a wide common-mode range.

The transceiver interfaces the single-ended CAN controller with the differential CAN bus found in industrial and automotive applications. It operates over the -7-V to 12-V common-mode range of the bus and will withstand common-mode transients of -25 V to 18 V as well as Schaffner tests. Performance features include high differential-input impedance, a symmetrical-differential-signal driver and very-low propagation delay that improves bus bandwidth and length by reducing reflection and distortion.

The transceiver operates over a wide temperature range, -40°C to 85°C and is available in 8-pin SOIC and dual-in-line packages.

block diagram



UDG-96202



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



functional table (VCC = 4.5 V to 5.5 V)

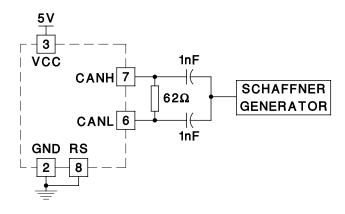
Inp	uts	0	Outrant Marila	Out	puts
TXD	RS	System Mode	Output Mode	VCANH - VCANL	RXD
0	0	High Speed	Dominant	1.5 V to 3 V	0
1	0	High Speed	Recessive	-120 mV to 12 mV	1
High Z	0	High Speed	Recessive	-120 mV to 12 mV	1
		0, "			0 at Bus = Dominant
X	1	Standby	_	High Z	1 at Bus = Recessive

absolute maximum ratings over operating free-air temperature (unless otherwise noted)†

	_
Supply voltage	0.3 V to 9 V
TXD, RXD, VREF, RS	0.3 V to VCC + 0.3 V
CANL, CANH, (0 V < VCC < 5.5 V)	
CANL, CANH, (non-destructive, non-operative)	
CANL, CANH, (transient, Schaffner test) See Figure 1	–150 V to 100 V
Operating temperature	
Storage temperature, T _{stg}	
Junction temperature, T_{J}	
Lead temperature (soldering, 10 sec.)	300°C
Crosswire protection maximum VBUS	30 V
Bus differential voltage*	30 V
Cross wire protection T _A	–40°C to 125°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

[★]Refers to Figures 9, 10, 11, 12 and 13.



NOTE: See Figure 7 for pulse timing.

UDG-96203-1

Figure 1. Schaffner Test



[‡] Currents are positive into, negative out of the specified terminal. Consult Packaging Section of the *Interface Products Data Book* (TI Literature Number SLUU002) for thermal limitations and considerations of packages.

electrical characteristics (total device disconnected from the bus line), VCC = 4.5 V to 5.5 V, 60 Ω in parallel with 100-pF load between CANH and CANL, $T_A = -40^{\circ}C$ to 85°C, $T_A = T_J$, (unless otherwise stated)

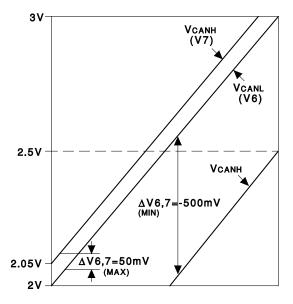
PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNITS
Supply voltage		4.5		5.5	V
	Dominant, TXD = 1 V			70	mA
Supply current	Recessive, TXD = 4 V		9	14	mA
	Standby, RS = 4 V		1.2	2.0	mA
RS input current		-10		5	μΑ
RS voltage input = logic 1	Standby	0.75VCC			V
RS Voltage Input = logic 0	High speed			0.3VCC	V
Transmitter voltage input = logic 1	Transmitter output recessive	0.7VCC			V
Transmitter voltage input = logic 0	Transmitter output dominant			0.3VCC	V
Transmitter current input at logic 1	TXD = 4 V			30	μΑ
Transmitter current input at logic 0	TXD = 1 V	-30		30	μΑ
Receiver voltage output = logic 1	RXD = -100 mA, TXD = 4 V	VCC -1.25			V
B	$RXD = 1 \text{ mA}, \qquad TXD = 1 \text{ V}$		0.75	1.2	V
Receiver voltage output = logic 0	RXD = 10 mA,		1.2	1.7	V
CANH, CANL input resistance	No load, TXD = 4 V	20	40		kΩ
Differential input resistance	No load, TXD = 4 V	40	80		kΩ
CANH, CANL input capacitance	See Note 1			20	pF
Differential input capacitance	See Note 1			10	pF
Reference output voltage	VREF = ±50 mA	0.45VCC		0.55VCC	V

NOTE 1: Ensured by design. Not production tested.



electrical characteristics, (dc parameters for recessive state disconnected from the bus line), 60 Ω in parallel with 100-pF load between CANH and CANL, $T_A = -40^{\circ}C$ to 85°C, $T_A = T_J$, (unless otherwise stated)

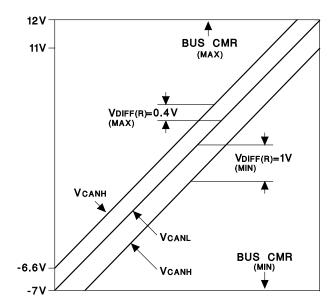
PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNITS
VCANH, VCANL	No load,	TXD = 4 V,	See Figure 2		2	2.5	3	V
Differential output transmitter (VCANH - VCANL)	No load,	TXD = 4 V,	See Figure 2		-500	0	50	mV
Differential input receiver		de range = -7 V to 12 V, externally driven	TXD = 4 V, See Figure 3		-1		0.40	V
Differential input resistance	No load				40			kΩ
CANH, CANL input resistance					20			kΩ



NOTE: Valid output of CANH, CANL during recessive state transmission. TXD = LOGIC 1

UDG-96204

Figure 2. Recessive State Voltage Diagram

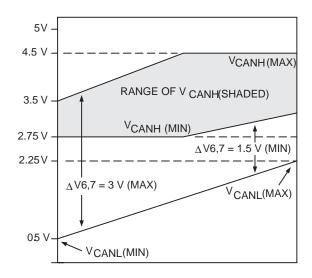


NOTE: Valid voltage range of V_{CANH} for sensing dominant bus state as V_{CANL} varies over bus common range mode. TXD = LOGIC1 UDG-96205

Figure 3. Recessive State Voltage Diagram

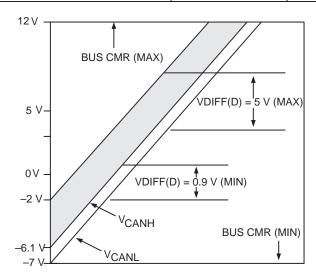
electrical characteristics, (dc parameters for dominant state disconnected from the bus line), 60 Ω in parallel with 100-pF load between CANH and CANL. VCC = 4.5 V to 5.5 V,) (unless otherwise stated)

PARAMETER	TEST CONDITIONS		MIN	TYP	MAX	UNITS	
CANH output voltage (VCANH)	TXD = 1 V,	See Figure 4		2.75		4.5	V
CANL output voltage (VCANL)	TXD = 1 V,	See Figure 4		0.50	1.1	2.25	V
Differential output transmitter (VCANH - VCANL)	TXD = 1 V,	See Figure 4		1.5	2	3	V
Differential input receiver (VDIFF(D))		range = -2 to 7 V, xternally driven,	TXD = 4 V, See Figure 5	0.9		5	V
	Common mode range = -7 to 12 V, CANH, CANL externally driven,		TXD = 4 V, See Figure 5	1.0		5	V



NOTE: Valid voltage range of V_{CANH} for sensing dominant bus state as V_{CANL} varies. TXD = LOGIC 0 UDG-97160

Figure 4. Dominant State Voltage Diagram



NOTE: Valid voltage range of V_{CANH} for sensing dominant bus state as V_{CANL} varies over bus common mode range.

TXD = LOGIC 0

Figure 5. Dominant State Voltage Diagram



transmitter characteristics, (disconnected from the bus line), 60 Ω in parallel with 100-pF load between CANH and CANL, (unless otherwise stated)

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNITS
Differential output transmitter	Dominant mode	1.5	2	3	V
(VCANH - VCANL)	Recessive mode	-500		50	mV
Delay from TXD to bus active TON (TXD)	See Figure 6		50	100	ns
Delay from TXD to bus inactive T _{OFF} (TXD)	60 Ω across CANH and CANL, See Figure 6		20	110	ns

receiver characteristics, (disconnected from the bus line), 60 Ω in parallel with 100-pF load between CANH and CANL, (unless otherwise stated)

PARAMETER	TE	TEST CONDITIONS			MAX	UNITS
Differential input receiver	Dominant mode,	TXD = 4 V	0.9			V
(VCANH – VCANL)	Recessive mode,	TXD = 4 V			0.4	V
Differential input hysteresis	TXD = 4 V		75	150		mV
Delay From Bus to RXD (TON)	Inactive to active bus,	See Figure 6		60	100	ns
Delay from bus to RXD (T _{OFF})	Active to inactive bus, See Figure 6	60 Ω across CANH and CANL,		80	115	ns

transceiver characteristics

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNITS
	T _{ON} (TXD) + T _{ON} (RXD) inactive to active bus		110	200	ns
Loop time	TOFF (TXD) + TOFF (RXD) active to inactive bus		100	225	ns

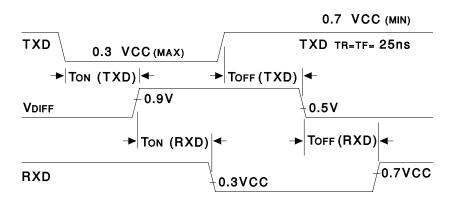


Figure 6. Transceiver ac Response

UDG-96208



APPLICATION INFORMATION

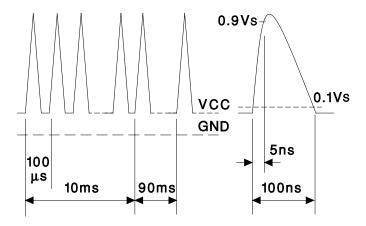


Figure 7. Timing Diagram for Schaffner Tests

Table 1. Magnitude Specifications for V_S

ISO	DIN 40839-1	Schaffner
DP7637/1	(Draft)	NSG500C/506C
Up to 150 V	Up to 150 V	40 V to 200 V

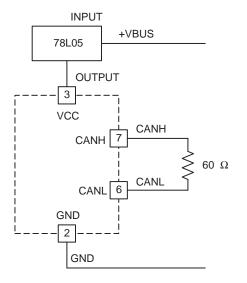


Figure 8. Normal Connection

OUTPUT

OUTPUT

VCC

VCC

CANH 7 +VBUS

CANL 6 GND

GND

CANL 6

CANL 6

CANL

CANH

INPUT

78L05

Figure 9. Crosswire No. 1

UDG-97176

UDG-96209

UDG-97175

APPLICATION INFORMATION

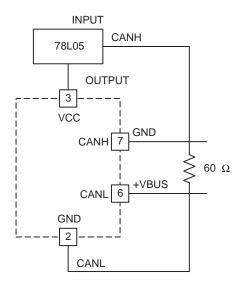


Figure 10. Crosswire No. 2 UDG-97177

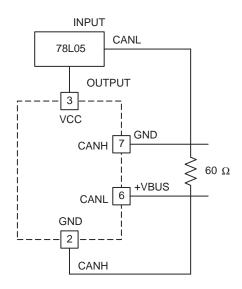


Figure 11. Crosswire No. 3 UDG-97178

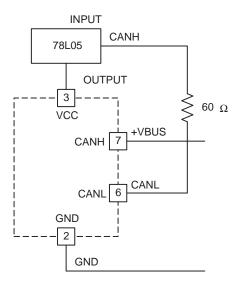


Figure 12. Crosswire No. 4 UDG-97179

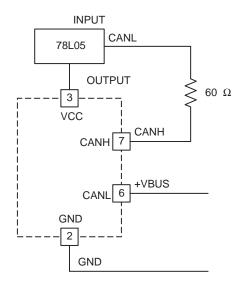


Figure 13. Crosswire No. 5 UDG-97180

IMPORTANT NOTICE

Texas Instruments and its subsidiaries (TI) reserve the right to make changes to their products or to discontinue any product or service without notice, and advise customers to obtain the latest version of relevant information to verify, before placing orders, that information being relied on is current and complete. All products are sold subject to the terms and conditions of sale supplied at the time of order acknowledgment, including those pertaining to warranty, patent infringement, and limitation of liability.

TI warrants performance of its semiconductor products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are utilized to the extent TI deems necessary to support this warranty. Specific testing of all parameters of each device is not necessarily performed, except those mandated by government requirements.

Customers are responsible for their applications using TI components.

In order to minimize risks associated with the customer's applications, adequate design and operating safeguards must be provided by the customer to minimize inherent or procedural hazards.

TI assumes no liability for applications assistance or customer product design. TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right of TI covering or relating to any combination, machine, or process in which such semiconductor products or services might be or are used. TI's publication of information regarding any third party's products or services does not constitute TI's approval, warranty or endorsement thereof.

Copyright © 2000, Texas Instruments Incorporated